

### SJ-FET

# OSP20N60S, OSF20N60S, OSB20N60S 600V N-Channel MOSFET

#### **Description**

SJ-FET is new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. SJ-FET is suitable for various AC/DC power conversion inswitching mode operation for higher efficiency.

#### **Features**

- 600V @TJ = 150 ℃
- Typ. RDS(on) =  $0.16 \Omega$
- Ultra Low Gate Charge (typ. Qg = 63nC)
- 100% avalanche tested
- · Rohs Compliant



#### **Absolute Maximum Ratings**

Symbol	Parameter	OSB20N60S	OSP20N60S	OSF20N60S	Unit
V <sub>DSS</sub>	Drain-Source Voltage		600		
I <sub>D</sub>	Drain Current -Continuous (TC = 25°C) -Continuous (TC = 100°C)	20* 12*	20 12	20* 12*	Α
I <sub>DM</sub>	Drain Current - Pulsed (Note 1)	60*	60	60*	Α
V <sub>GSS</sub>	Gate-Source voltage	±30			V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	Energy (Note 2) 600			mJ
I <sub>AR</sub>	Avalanche Current (Note 1)		20		Α
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		mJ		
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.5			V/ns
P <sub>D</sub>	Power Dissipation (TC = 25°C) -Derate above 25°C	ver Dissipation (TC = 25°C) 151 151 35		W W/℃	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150		$^{\circ}$ C
T <sub>L</sub>	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds	300			$^{\circ}$ C

<sup>\*</sup> Drain current limited by maximum junction temperature.

#### **Thermal Characteristics**

Symbol	Parameter	OSB20N60S	OSP20N60S	OSF20N60S	Unit
R B JC Thermal Resistance, Junction-to-Case		1.5	0.6	3.6	°C/W
R o CS	Thermal Resistance, Case-to-Sink Typ.	0.5			°C/W
R <sub>0 JA</sub>	Thermal Resistance, Junction-to-Ambient	75	62	62	°C/W

### Electrical Characteristics TC = 25°C unless otherwise noted

Symbol	Parameter Conditions		Min	Тур	Max	Unit
Off Characterist	tics					
		VGS = 0V, ID = 250µA, TJ = 25℃	600			V
BVDSS	Drain-Source Breakdown Voltage	VGS = 0V, ID = 250μA, TJ = 150°C		650		V
ΔBVDSS / ΔTJ	Breakdown Voltage Temperature Coefficient	ID = 250μA, Referenced to 25℃		0.6		V/°C
IDSS	Zero Gate Voltage Drain Current	VDS = 600V, VGS = 0V VDS =480V, TC = 125℃			1 10	μA μA
IGTSF	Gate-Body Leakage Current, Forward	VGS = 30V, VDS = 0V			100	nA
IGSSR	Gate-Body Leakage Current, Reverse	VGS = -30V, VDS = 0V			-100	nA
On Characterist	ics					
VGS(th)	Gate Threshold Voltage	VDS = VGS, ID = 250μA	2.5		4.5	V
RDS(on)	Static Drain-Source On-Resistance	VGS = 10V, ID = 10A		0.16	0.19	Ω
gFS	Forward Transconductance	VDS = 40V, ID =5A (Note 4)		16		S
Rg	Gate Resistance	F=1MHz, open drain		4.5		Ω
<b>Dynamic Chara</b>	cteristics					
Ciss	Input Capacitance	VDS = 25V, VGS = 0V, f = 1.0MHz		1440	1870	pF
Coss	Output Capacitance			345	450	pF
Crss	Reverse Transfer Capacitance			70		pF
<b>Switching Char</b>	acteristics					
td(on)	Turn-On Delay Time	VDD = 400V, ID = 10A RG = 20 Ω (Note 4, 5)		25		ns
tr	Turn-On Rise Time			55		ns
td(off)	Turn-Off Delay Time			70		ns
tf	Turn-Off Fall Time			40		ns
Qg	Total Gate Charge	VDS = 480V, ID = 20A VGS = 10V		63		nC
Qgs	Gate-Source Charge	(Note 4, 5)		7.6		nC
Qgd	Gate-Drain Charge			32		nC
	iode Characteristics and Maximu	ım Ratings				
IS	Maximum Continuous Drain-Source Diode Forward Current				20	А
ISM	Maximum Pulsed Drain-Source Diode Forward Current				60	Α
VSD	Drain-Source Diode Forward Voltage	VGS = 0V, IS = 10A			1.5	V
trr	Reverse Recovery Time			475		ns
Qrr	Reverse Recovery Charge	VGS = 0V, IS = 10A dIF/dt =100A/µs (Note 4)		5.8		μC
Irrm	Peak Reverse Recovery Current	<u> </u>		35		Α

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature 2. L=10.5mH, I  $_{\rm AS}$ =10A, VDD=150V, Starting TJ=25  $^{\circ}{\rm C}$
- 3.  $I_{SD} \le 20A$ , di/dt  $\le 200A$ /us,  $V_{DD} \le BV_{DSS}$ , Starting TJ = 25  $^{\circ}$ C 4. Pulse Test: Pulse width  $\le 300$ us, Duty Cycle  $\le 2\%$
- 5. Essentially Independent of Operating Temperature Typical Characteristics

### **Typical Performance Characteristics**

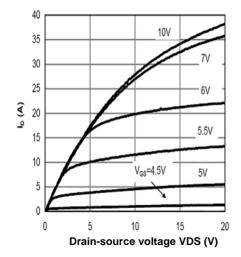
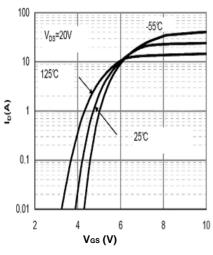


Figure 1: On-Region Characteristics@25° C



**Figure 3: Transfer Charateristics** 

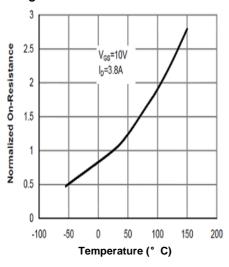


Figure 5: On-Resistance vs. Junction Temperature

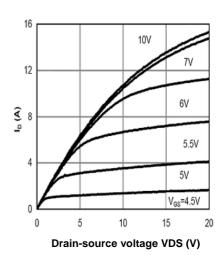


Figure 2: On-Region Characteristics@125° C

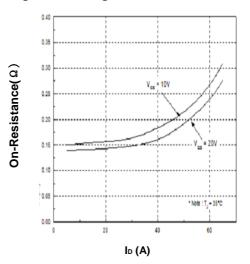


Figure 4: On-Resistance vs. Drain Current (ID)

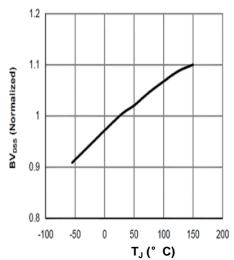


Figure 6: Break Down vs. Junction Temperature

### **Typical Performance Characteristics**

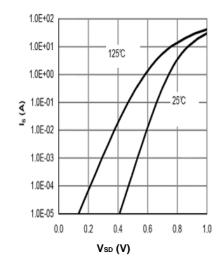


Figure 7: Body-Diode Characteristics

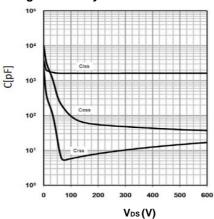


Figure 9: Capacitance Characteristics C=f(VDS), VGS=0V, f=1MHz

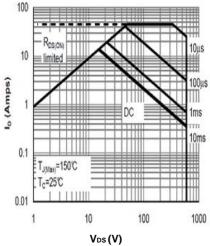


Figure 11: Maximum Forward Biased Safe Operating Area

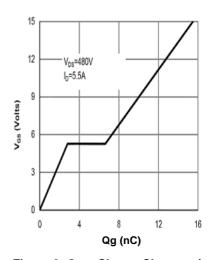


Figure 8: Gate-Charge Characteristics

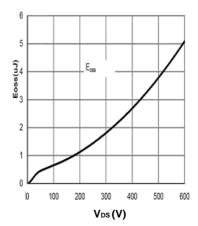


Figure 10: Coss stored Energy

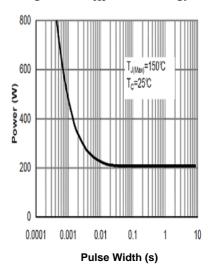


Figure 12: Single Pulse Power Rating Junction to Case

### **Typical Performance Characteristics**

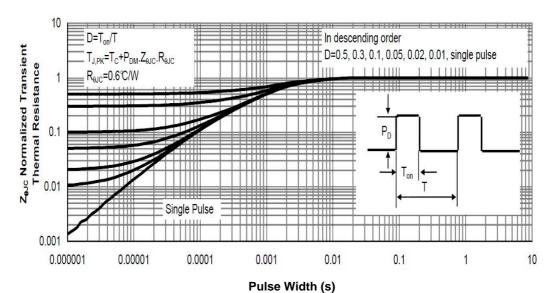
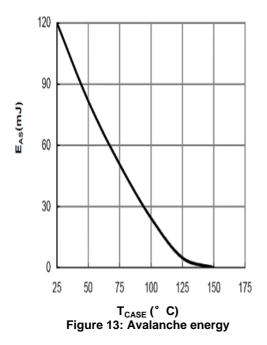
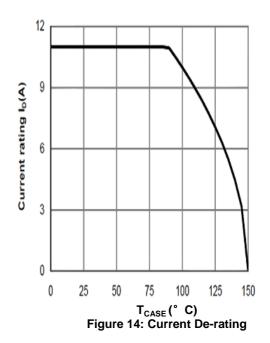
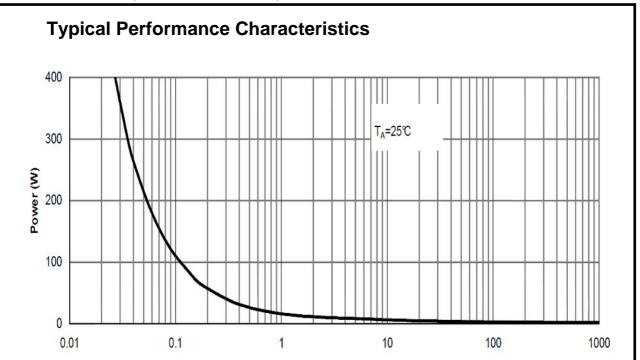


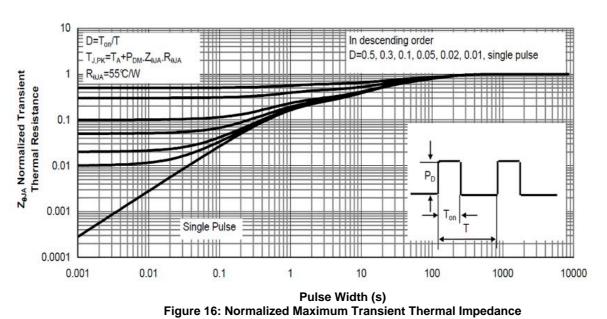
Figure 12: Normalized Maximum Transient Thermal Impedance





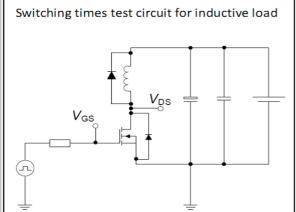


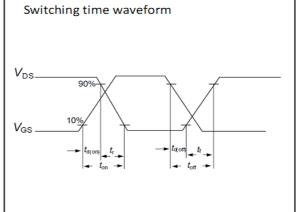
Pulse Width (s) Figure 15: Single Pulse Power Rating Junction-Ambient



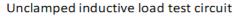
### **Test circuits**

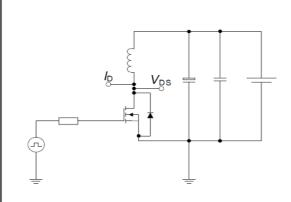
Switching times test circuit and waveform for inductive load

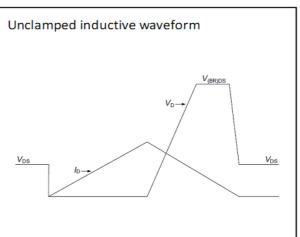




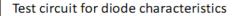
### Unclamped inductive load test circuit and waveform

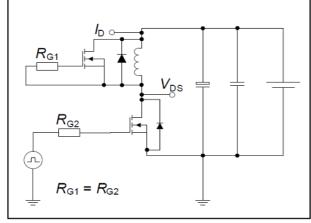


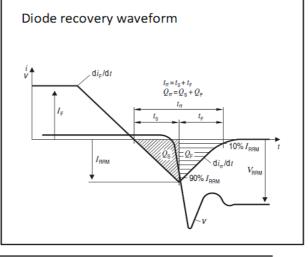


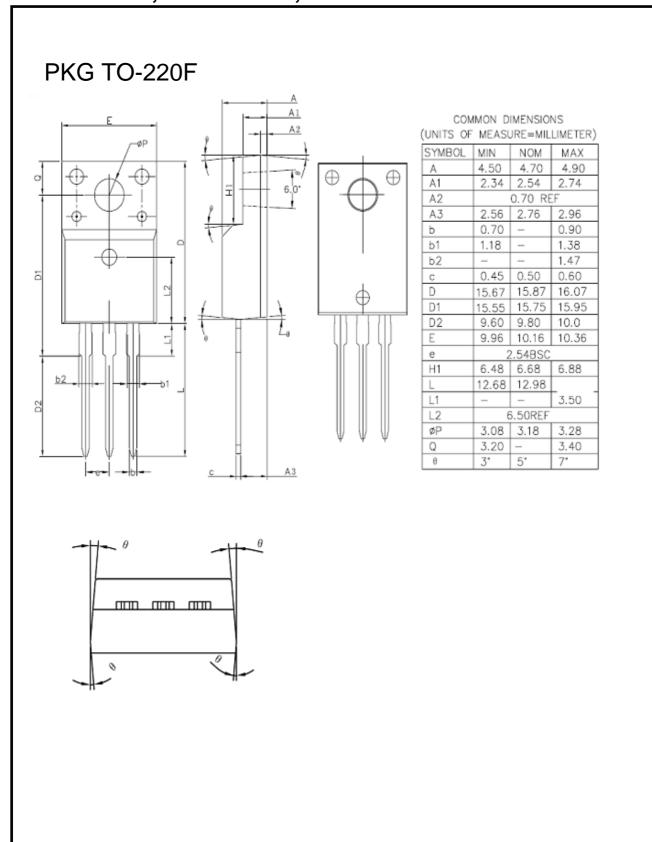


#### Test circuit and waveform for diode characteristics

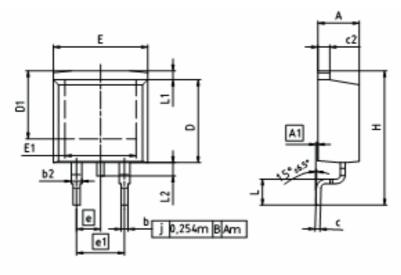


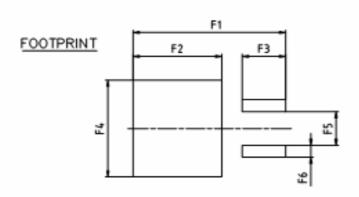












DIM	MILLIM	ETERS	INCH	(ES	
DIM	MN	MAX	MIN	MAX	
Α	4.30	4.57	0.169	0.180	
A1	0.00	0.26	0.000	0.010	
b	0.85	0.85	0.028	0.033	
b2	0.95 1.15 0.037		0.037	0.045	
c	0.33	0.65	0.013	0.026	
¢2	1.17	1.40	0.048	0.065	
D	8.51	9.45	0.335	0.372	
D1	7.10	7.90	0.280	0.311	
Ε	9.80	10.31	0.366	0.406	
E1	6.80	8.60	0.266	0.339	
e	2.54		0.100		
e1	5.08		0.200		
N	2		2		
н	14.81	15.88	0.575	0.625	
L	2.29	3.00	0.090	0.118	
L1	0.70	1.60	0.028	0.063	
L2	1.00	1.78	0.039	0.070	
F1	16.05	16.25	0.632	0.640	
F2	9.30	9.60	0.366	0.374	
F3	4.80	4.70	0.177	0.185	
F4	10.70	10.90	0.421	0.429	
F5	3.85	3.85	0.144	0.152	
F6	1.25	1.45	0.049	0.057	

